

1140 Series

2.00 mm Header Socket
 DIP Solder Type, Straight

Ordering Information

1140 - X X X - XX S - X

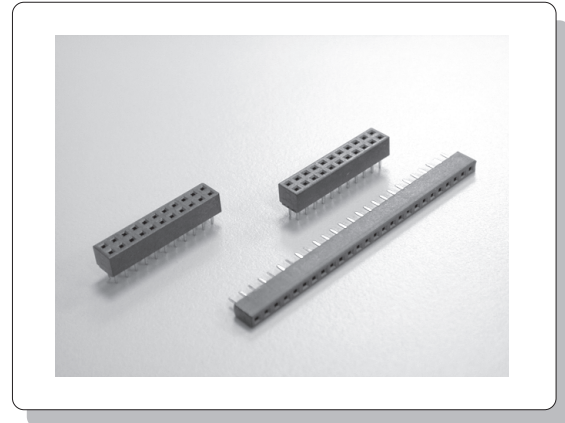
Contact Plating
 A - Gold Flash
 B - 10 μ" Gold
 C - 15 μ" Gold
 D - 20 μ" Gold

NO. of Row
 1 - single row
 2 - dual row

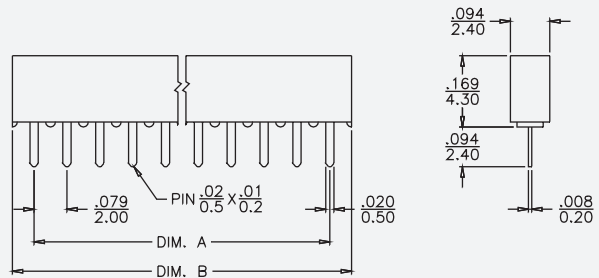
Insulator Type
 0 - Type 0

PIN Length
 B - 2.4mm
 S - Straight

NO. of Contact
 02-40 PIN (single row)
 04-80 PIN (dual row)



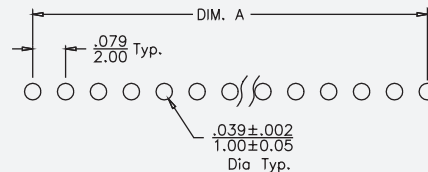
Dimensions



$$\text{DIM. A} = \frac{.079"}{2.00\text{mm}} \times \langle \text{NO. OF SPACE} \rangle$$

$$\text{DIM. B} = \text{DIM. A} + \frac{.079"}{2.00\text{mm}}$$

RECOMMENDED P.C.B. LAYOUT



Specification

Materials:

- ♦ **Insulator:** Glass Fiber Reinforced Thermoplastic, UL94V-0.
- ♦ **Contact:** Copper Alloy.
- ♦ **Plating:** Gold

Electrical:

- ♦ **Insulation Resistance:** 5000 MΩ Minimum.
- ♦ **Dielectric Withstanding Voltage:** 500 VAC R.M.S.
- ♦ **Voltage Rating:** 250VAC R.M.S.
- ♦ **Current Rating:** 1 AMP.
- ♦ **Contact Resistance:** 20 mΩ Maximum.

Environmental

- ♦ Temperature: -55°C to +125°C

- ❖ All Dimensions are shown in in/mm.
- ❖ The above ordering data is for our standard products.
 For Non-Standard products, please contact
 TEKCON Electronics Corporation.